TYPE	TYPICAL MAXIMUM CLOCK FREQUENCY	TYPICAL POWER DISSIPATION
′95A	36 MHz	195 mW
'LS95B	36 MHz	65 mW

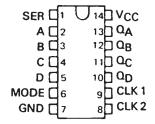
### description

These 4-bit registers feature parallel and serial inputs, parallel outputs, mode control, and two clock inputs. The registers have three modes of operation:

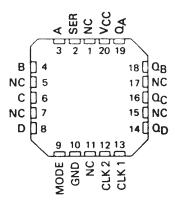
Parallel (broadside) load Shift right (the direction  $Q_{\Delta}$  toward  $Q_{D}$ ) Shift left (the direction QD toward QA)

Parallel loading is accomplished by applying the four bits of data and taking the mode control input high. The data is loaded into the associated flip-flops and appears at the outputs after the high-to-low transition of the clock-2 input. During loading, the entry of serial data is inhibited.

Shift right is accomplished on the high-to-low transition of clock 1 when the mode control is low; shift left is accomplished on the high-to-low transition of clock 2 when the mode control is high by connecting the output of each flip-flop to the parallel input of the previous flip-flop (QD to input C, etc.) and serial data is entered at input D. The clock input may be applied commonly to clock 1 and clock 2 if both modes can be clocked from the same source. Changes at the mode control input should normally be made while both clock inputs are low; however, conditions described in the last three lines of the function table will also ensure that register contents are protected. SN5495A, SN54LS95B . . . J OR W PACKAGE SN7495A . . . N PACKAGE SN74LS95B . . . D OR N PACKAGE (TOP VIEW)



SN54LS95B . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

#### **FUNCTION TABLE**

			INPUTS						OUT	PUTS	
MODE	CLO	CKS	CERIAL		PAR	ALLEL			0.0	α <sub>C</sub>	$\alpha_{D}$
CONTROL	2 (L)	1 (R)	SERIAL	Α	В	С	D	Q <sub>A</sub>	ΩB	<u> </u>	ω <sub>D</sub>
Н	н	Х	Х	Х	Х	Х	х	QAO	$Q_{BO}$	$\sigma_{C0}$	$\sigma^{DO}$
н	+	X	x	a	ь	С	d	а	b	С	d
H	1 +	X	×	QBt	Q <sub>C</sub> †	QDt	d	Q <sub>Bn</sub>	$a_{Cn}$	$a_{Dn}$	d
L	L	н	×	×	X	X	X	QAO	$\alpha_{BO}$	$\sigma_{CO}$	$\sigma_{DO}$
L	×	<b>‡</b>	н	х	X	X	X	н	$Q_{An}$	QBn	$\sigma_{Cu}$
L	×	1	L	х	X	X	X	L	$Q_{An}$	QBn	$a_{Cn}$
†	L	L	×	X	Х	X	X	QAO	$Q_{BO}$	$a_{co}$	$Q_{DO}$
4	L	L	×	х	X	X	X	QAO	$Q_{BO}$	$a_{C0}$	$a_{DO}$
4	L	н	×	x	X	×	X	QAO	Q <sub>BO</sub>	$a_{C0}$	$\sigma_{DO}$
†	н	L	×	x	X	×	×	QAO	$Q_{BO}$	$a_{C0}$	$\sigma_{\text{DO}}$
†	Н	н	×	x	Х	X	X	QAO	QBO	$a_{C0}$	$\sigma_{DO}$

†Shifting left requires external connection of  $Q_B$  to A,  $Q_C$  to B, and  $Q_D$  to C. Serial data is entered at input D. H = high level (steady state), L = low level (steady state), X = irrelevant (any input, including transitions)

1 = transition from high to low level, 1 = transition from low to high level

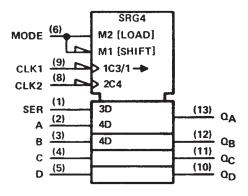
a, b, c, d = the level of steady-state input at inputs A, B, C, or D, respectively.

 $Q_{A0}$ ,  $Q_{B0}$ ,  $Q_{C0}$ ,  $Q_{D0}$  = the level of  $Q_{A}$ ,  $Q_{B}$ ,  $Q_{C}$ , or  $Q_{D}$ , respectively, before the indicated steady-state input conditions were established.

 $Q_{An}$ ,  $Q_{Bn}$ ,  $Q_{Cn}$ ,  $Q_{Dn}$  = the level of  $Q_{A}$ ,  $Q_{B}$ ,  $Q_{C}$ , or  $Q_{D}$ , respectively, before the most-recent  $\downarrow$  transition of the clock.

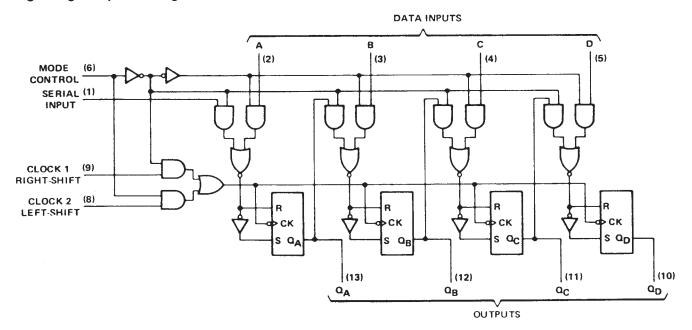


## logic symbol†



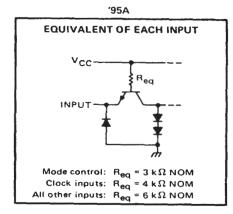
 $<sup>^\</sup>dagger$  This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for D, J, N, and W packages.

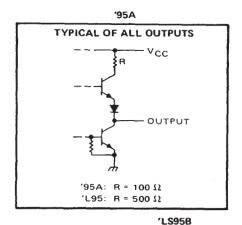
### logic diagram (positive logic)

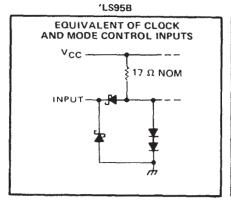


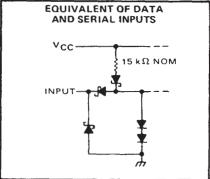


# schematics of inputs and outputs

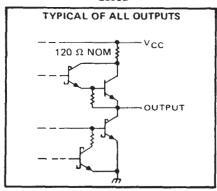








'LS95B



# absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

	SN54'	SN54LS'	SN74'	SN74LS'	UNIT
Supply voltage, V <sub>CC</sub> (see Note 1)	7	7	7	7	V
Input voltage	5.5	7	5.5	7	V
Interemitter voltage (see Note 2)	5.5		5.5		V
Operating free-air temperature range	- 55	to 125 0 to 70		to 70	°C
Storge temperature range	- 65	to 150	- 65 to 150		°C

- NOTES: 1. Voltage values, except interemitter voltage, are with respect to network ground terminal.
  - 2. This is the voltage between two emitters of a multiple-emitter input transistor. This rating applies between the clock-2 input and the mode control input of the '95A.

### recommended operating conditions

		SN5495A			SN7495A		
	MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Supply voltage, VCC	4.5	5	5.5	4.75	5	5.25	٧
High-level output current, IOH			-800			-800	μΑ
Low-level output current, IOL			16			16	mA
Clock frequency, f <sub>clock</sub>	0		25	0		25	MHz
Width of clock pulse, tw(clock) (See Figure 1)	20			20			กร
Setup time, high-level or low-level data, t <sub>su</sub> (See Figure 1)	15			15			กร
Hold time, high-level or low-level data, th (See Figure 1)	0			0			ns
Time to enable clock 1, tenable 1 (See Figure 2)	15			15			ns
Time to enable clock 2 (See Figure 2)	15			15			กร
Time to inhibit clock 1, tinhibit 1 (See Figure 2)	5			5			กร
Time to inhibit clock 2, tinhibit 2 (See Figure 2)	5			5			ns
Operating free-air temperature, TA	55		125	0		70	°C

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER			:	SN5495	A	SN7495A			
	PARAME	TER	TEST CONDITIONS <sup>†</sup>	MIN	TYP‡	MAX	MIN	TYP <sup>‡</sup>	MAX	UNIT
VIH	High-level input voltage	је		2			2			٧
VIL	Low-level input voltage	je				0.8			0.8	٧
VIK	Input clamp voltage		V <sub>CC</sub> = MIN, I <sub>I</sub> =12 mA			-1.5			-1.5	V
		V <sub>CC</sub> = MIN, V <sub>IH</sub> = 2 V,		2.4		2.4	3.4		V	
VOH	High-level output voltage		$V_{1L} = 0.8 \text{ V},  I_{OH} = -800 \mu\text{A}$	2.4	3.4		2.4	3.4		, v
VOL	Low-level output voltage		V <sub>CC</sub> = MIN, V <sub>IH</sub> = 2 V,			0.4		0.2	0.4	V
			V <sub>1L</sub> = 0.8 V, I <sub>OL</sub> = 16 mA		0.2	0.4		0.2	0.4	
Ц	Input current at maximum input volta	ge	V <sub>CC</sub> = MAX, V <sub>I</sub> = 5.5 V			1			1	mA
	High-level	Serial, A, B, C, D,	V <sub>CC</sub> = MAX, V <sub>1</sub> = 2.4 V			40	,		40	
ЧН	input current	Clock 1 or 2								μA
	mpat carrent	Mode control				80			80	
	Low-level	Serial, A, B, C, D,				-1.6			-1.6	
HE		Clock 1 or 2	V <sub>CC</sub> = MAX, V <sub>I</sub> = 0.4 V			1.0				mA
	input current	Mode control		<u> </u>		-3.2			-3.2	
los	Short-circuit output current§		V <sub>CC</sub> = MAX	-18		-57	-18		-57	mA
Icc	Supply current		V <sub>CC</sub> = MAX, See Note 3		39	63		39	63	mA

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

# switching characteristics, $V_{CC} = 5 \text{ V}$ , $T_A = 25^{\circ} \text{ C}$

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
f <sub>max</sub> Maximum clock frequency	0 - 15 - 5 - 8 - 200 0	25	36		MHz
tpLH Propagation delay time, low-to-high-level output from clock	$C_L = 15 \mathrm{pF},  R_L = 400 \Omega,$ See Figure 1		18	27	ns
tpHL Propagation delay time, high-to-low-level output from clock	- See Figure 1		21	32	ns



 $<sup>^{\</sup>ddagger}$  All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25 °C.

<sup>§</sup> Not more than one output should be shorted at a time.

NOTE 3: ICC is measured with all outputs and serial input open; A, B, C, and D inputs grounded; mode control at 4.5 V; and a momentary 3 V, then ground, applied to both clock inputs.

#### recommended operating conditions

	SI	SN54LS95B			SN74LS95B		
	MIN N	NOM	MAX	MIN	NOM	MAX	UNIT
Supply voltage, VCC	4.5	5	5.5	4.75	5	5.25	٧
High-level output current, IOH			-400			-400	μΑ
Low-level output current, IOL			4			8	mA
Clock frequency, fclock	0		25	0		25	MHz
Width of clock pulse, tw(clock) (see Figure 1)	20			20			ns
Setup time, high-level or low-level data, t <sub>su</sub> (see Figure 1)	20			20			ns
Hold time, high-level or low-level data, th (see Figure 1)	20			10			ns
Time to enable clock 1, tenable 1 (see Figure 2)	20			20			ns
Time to enable clock 2, tenable 2 (see Figure 2)	20			20			ns
Time to inhibit clock 1, tinhibit 1 (see Figure 2)	20			20			ns
Time to inhibit clock 2, tinhibit 2 (see Figure 2)	20			20			ns
Operating free-air temperature, TA	-55		125	0		70	°c

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER				St	<b>N54LS9</b>	58	Sf	UNIT		
		TEST COM	TEST CONDITIONS <sup>†</sup>		TYP <sup>‡</sup>	MAX	MIN	TYP <sup>‡</sup>	MAX	ONLI
ViH	High-level input voltage			2			2			V
VIL	Low-level input voltage					0.7			8.0	V
VIK	Input clamp voltage	V <sub>CC</sub> = MIN,	I <sub>1</sub> = -18 mA			-1.5			-1.5	V
	High-level output voltage	V <sub>CC</sub> = MIN, V <sub>IL</sub> = V <sub>IL</sub> max,	V <sub>1H</sub> = 2 V, I <sub>OH</sub> = -400 μA	2.5	3.4		2.7	3.4		V
	Low-level output voltage	V <sub>CC</sub> = MIN,	IOL = 4 mA		0.25	0.4		0.25	0.4	
VOL		V <sub>IH</sub> = 2 V, V <sub>IL</sub> = V <sub>IL</sub> max	1 <sub>OL</sub> = 8 mA					0.35	0.5	Ľ.
l <sub>l</sub>	Input current at maximum input voltage	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 7 V			0.1			0.1	mA
ЧН	High-level input current	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 2.7 V			20			20	μА
IIL	Low-level input current	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 0.4 V			-0.4			-0.4	mA
los	Short-circuit output current \$	V <sub>CC</sub> = MAX		-20		-100	20		-100	mA
Icc	Supply current	V <sub>CC</sub> = MAX,	See Note 3		13	21	<u> </u>	13	21	mA

<sup>&</sup>lt;sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

# switching characteristics, $V_{CC}$ = 5 V, $T_A$ = 25°C

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
f <sub>max</sub> Maximum clock frequency	$C_{\parallel} = 15  \text{pF},  R_{\parallel} = 2  \text{k}\Omega,$	25	36		MHz
tPLH Propagation delay time, low-to-high-level output from clock	See Figure 1		18	27	ns
tpHL Propagation delay time, high-to-low-level output from clock	]		21	32	ns

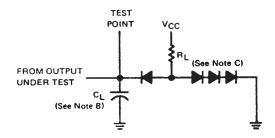


<sup>&</sup>lt;sup>‡</sup> All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25 \,^{\circ}\text{C}$ .

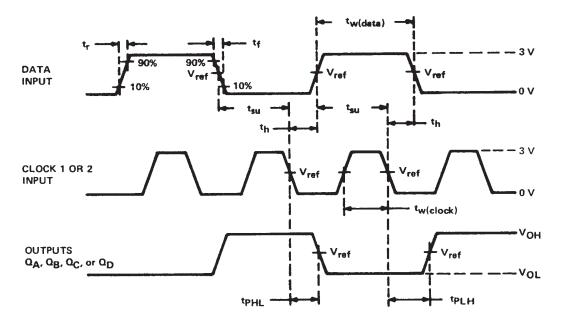
<sup>§</sup> Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

NOTE 3: ICC is measured with all outputs and serial input open; A, B, C, and D inputs grounded; mode control at 4.5 V; and a momentary 3 V, then ground, applied to both clock inputs.

#### PARAMETER MEASUREMENT INFORMATION



LOAD CIRCUIT

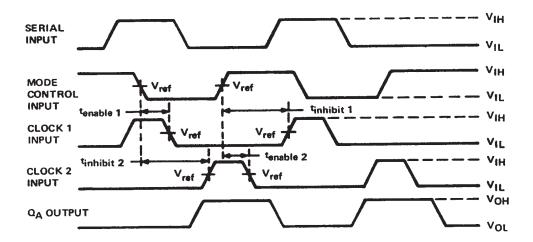


- NOTES: A. Input pulses are supplied by a generator having the following characteristics:  $t_f \le 10$  ns,  $t_f \le 10$  ns, and  $Z_{out} \approx 50$   $\Omega$ . For the data pulse generator, PRR = 500 kHz; for the clock pulse generator, PRR = 1 MHz. When testing  $f_{max}$ , vary PRR. For '95A,  $t_{w\{data\}}$  $\geq$  20ns,  $t_{w(clock)} \geq$  15 ns. For 'LS95B,  $t_{w(data)} \geq$  20 ns,  $t_{w(clock)} \geq$  15 ns.
  - B. C<sub>L</sub> includes probe and jig capacitance.
  - C. All diodes are 1N3064 equivalent.
  - D. For '95A,  $V_{ref}$  = 1.5 V; for 'LS95B,  $V_{ref}$  = 1.3 V.

**VOLTAGE WAVEFORMS FIGURE 1-SWITCHING TIMES** 



# PARAMETER MEASUREMENT INFORMATION



NOTES: A. Input is at a low level.

B. For '95A,  $V_{ref} = 1.5 \text{ V}$ ; for 'LS958,  $V_{ref} = 1.3 \text{ V}$ .

VOLTAGE WAVEFORMS
FIGURE 2-CLOCK ENABLE/INHIBIT TIMES



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